Electronic Patent Application Fee Transmittal							
Application Number:	107	10788979					
Filing Date:	27-	27-Feb-2004					
Title of Invention:	Вас	Backside rapid thermal processing of patterned wafers					
First Named Inventor/Applicant Name:	Wo	Wolfgang Aderhold					
Filer:	Cha	Charles S. Guenzer					
Attorney Docket Number:	008	008304					
Filed as Large Entity							
Utility under 35 USC 111(a) Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Filing a brief in support of an appeal		1402	1	620	620		
Post-Allowance-and-Post-Issuance:							
Extension-of-Time:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			620